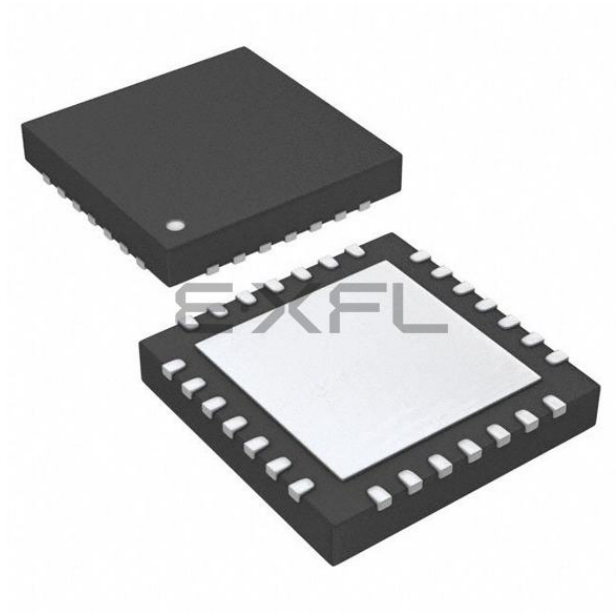

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	48MHz
Connectivity	I²C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, HLVD, POR, PWM, WDT
Number of I/O	24
Program Memory Size	16KB (8K x 16)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	768 x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 19x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	28-VQFN Exposed Pad
Supplier Device Package	28-QFN (6x6)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic18lf24k22-e-ml

FIGURE 5-7: DATA MEMORY MAP FOR PIC18(L)F25K22 AND PIC18(L)F45K22 DEVICES

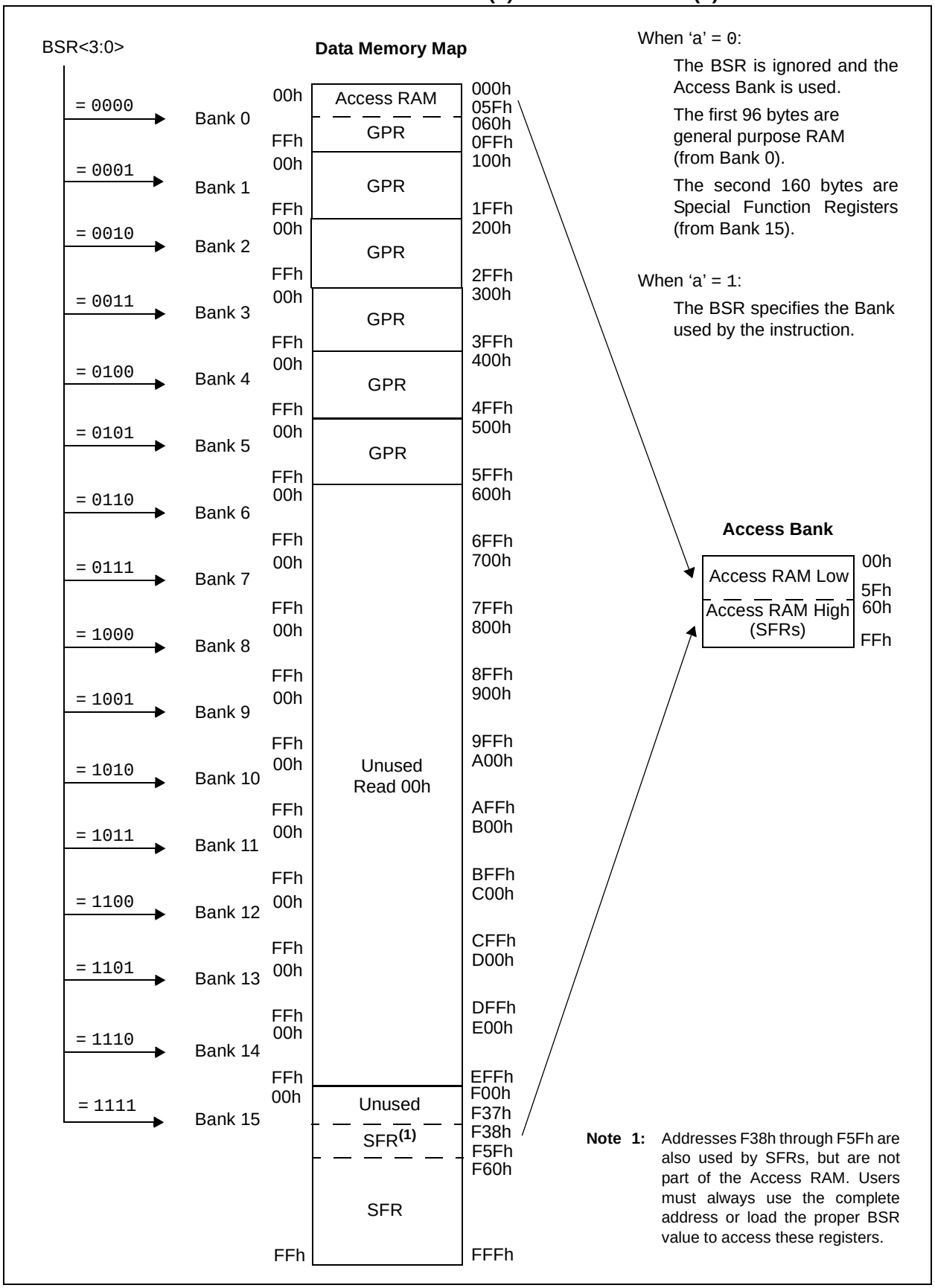


TABLE 5-1: SPECIAL FUNCTION REGISTER MAP FOR PIC18(L)F2X/4XK22 DEVICES

Address	Name	Address	Name	Address	Name	Address	Name	Address	Name
FFFh	TOSU	FD7h	TMR0H	FAFh	SPBRG1	F87h	—(2)	F5Fh	CCPR3H
FFEh	TOSH	FD6h	TMR0L	FAEh	RCREG1	F86h	—(2)	F5Eh	CCPR3L
FFDh	TOSL	FD5h	T0CON	FADh	TXREG1	F85h	—(2)	F5Dh	CCP3CON
FFCh	STKPTR	FD4h	—(2)	FACh	TXSTA1	F84h	PORTE	F5Ch	PWM3CON
FFBh	PCLATU	FD3h	OSCCON	FABh	RCSTA1	F83h	PORTD(3)	F5Bh	ECCP3AS
FFAh	PCLATH	FD2h	OSCCON2	FAAh	EEADRH(4)	F82h	PORTC	F5Ah	PSTR3CON
FF9h	PCL	FD1h	WDTCON	FA9h	EEADR	F81h	PORTB	F59h	CCPR4H
FF8h	TBLPTRU	FD0h	RCON	FA8h	EEDATA	F80h	PORTA	F58h	CCPR4L
FF7h	TBLPTRH	FCFh	TMR1H	FA7h	EECON2(1)	F7Fh	IPR5	F57h	CCP4CON
FF6h	TBLPTRL	FCEh	TMR1L	FA6h	EECON1	F7Eh	PIR5	F56h	CCPR5H
FF5h	TABLAT	FCDh	T1CON	FA5h	IPR3	F7Dh	PIE5	F55h	CCPR5L
FF4h	PRODH	FCCh	T1GCON	FA4h	PIR3	F7Ch	IPR4	F54h	CCP5CON
FF3h	PRODL	FCBh	SSP1CON3	FA3h	PIE3	F7Bh	PIR4	F53h	TMR4
FF2h	INTCON	FCAh	SSP1MSK	FA2h	IPR2	F7Ah	PIE4	F52h	PR4
FF1h	INTCON2	FC9h	SSP1BUF	FA1h	PIR2	F79h	CM1CON0	F51h	T4CON
FF0h	INTCON3	FC8h	SSP1ADD	FA0h	PIE2	F78h	CM2CON0	F50h	TMR5H
FEFh	INDF0(1)	FC7h	SSP1STAT	F9Fh	IPR1	F77h	CM2CON1	F4Fh	TMR5L
FEEh	POSTINC0(1)	FC6h	SSP1CON1	F9Eh	PIR1	F76h	SPBRGH2	F4Eh	T5CON
FEDh	POSTDEC0(1)	FC5h	SSP1CON2	F9Dh	PIE1	F75h	SPBRG2	F4Dh	T5GCON
FECh	PREINC0(1)	FC4h	ADRESH	F9Ch	HLVDCON	F74h	RCREG2	F4Ch	TMR6
FEBh	PLUSW0(1)	FC3h	ADRESL	F9Bh	OSCTUNE	F73h	TXREG2	F4Bh	PR6
FEAh	FSR0H	FC2h	ADCON0	F9Ah	—(2)	F72h	TXSTA2	F4Ah	T6CON
FE9h	FSR0L	FC1h	ADCON1	F99h	—(2)	F71h	RCSTA2	F49h	CCPTMRS0
FE8h	WREG	FC0h	ADCON2	F98h	—(2)	F70h	BAUDCON2	F48h	CCPTMRS1
FE7h	INDF1(1)	FBFh	CCPR1H	F97h	—(2)	F6Fh	SSP2BUF	F47h	SRCON0
FE6h	POSTINC1(1)	FBEh	CCPR1L	F96h	TRISE	F6Eh	SSP2ADD	F46h	SRCON1
FE5h	POSTDEC1(1)	FBDh	CCP1CON	F95h	TRISD(3)	F6Dh	SSP2STAT	F45h	CTMUCONH
FE4h	PREINC1(1)	FBCh	TMR2	F94h	TRISC	F6Ch	SSP2CON1	F44h	CTMUCONL
FE3h	PLUSW1(1)	FBBh	PR2	F93h	TRISB	F6Bh	SSP2CON2	F43h	CTMUICON
FE2h	FSR1H	FBAh	T2CON	F92h	TRISA	F6Ah	SSP2MSK	F42h	VREFCON0
FE1h	FSR1L	FB9h	PSTR1CON	F91h	—(2)	F69h	SSP2CON3	F41h	VREFCON1
FE0h	BSR	FB8h	BAUDCON1	F90h	—(2)	F68h	CCPR2H	F40h	VREFCON2
FDFh	INDF2(1)	FB7h	PWM1CON	F8Fh	—(2)	F67h	CCPR2L	F3Fh	PMD0
FDEh	POSTINC2(1)	FB6h	ECCP1AS	F8Eh	—(2)	F66h	CCP2CON	F3Eh	PMD1
FDDh	POSTDEC2(1)	FB5h	—(2)	F8Dh	LATE(3)	F65h	PWM2CON	F3Dh	PMD2
FDCh	PREINC2(1)	FB4h	T3GCON	F8Ch	LATD(3)	F64h	ECCP2AS	F3Ch	ANSELE
FDBh	PLUSW2(1)	FB3h	TMR3H	F8Bh	LATC	F63h	PSTR2CON	F3Bh	ANSELD
FDAh	FSR2H	FB2h	TMR3L	F8Ah	LATB	F62h	IOCB	F3Ah	ANSELC
FD9h	FSR2L	FB1h	T3CON	F89h	LATA	F61h	WPUB	F39h	ANSELB
FD8h	STATUS	FB0h	SPBRGH1	F88h	—(2)	F60h	SLRCON	F38h	ANSELA

Note 1: This is not a physical register.
2: Unimplemented registers are read as '0'.
3: PIC18(L)F4XK22 devices only.
4: PIC18(L)F26K22 and PIC18(L)F46K22 devices only.

TABLE 10-14: PORTE I/O SUMMARY

Pin	Function	TRIS Setting	ANSEL Setting	Pin Type	Buffer Type	Description
RE0/P3A/CCP3/AN5	RE0	0	0	O	DIG	LATE<0> data output; not affected by analog input.
		1	0	I	ST	PORTE<0> data input; disabled when analog input enabled.
	P3A(1)	0	0	O	DIG	Enhanced CCP3 PWM output.
	CCP3(1)	0	0	O	DIG	Compare 3 output/PWM 3 output.
		1	0	I	ST	Capture 3 input.
	AN5	1	1	I	AN	Analog input 5.
RE1/P3B/AN6	RE1	0	0	O	DIG	LATE<1> data output; not affected by analog input.
		1	0	I	ST	PORTE<1> data input; disabled when analog input enabled.
	P3B	0	0	O	DIG	Enhanced CCP3 PWM output.
	AN6	1	1	I	AN	Analog input 6.
RE2/CCP5/AN7	RE2	0	0	O	DIG	LATE<2> data output; not affected by analog input.
		1	0	I	ST	PORTE<2> data input; disabled when analog input enabled.
	CCP5	0	0	O	DIG	Compare 5 output/PWM 5 output.
		1	0	I	ST	Capture 5 input.
	AN7	1	1	I	AN	Analog input 7.
RE3/VPP/$\overline{\text{MCLR}}$	RE3	—	—	I	ST	PORTE<3> data input; enabled when Configuration bit MCLRE = 0.
	VPP	—	—	P	AN	Programming voltage input; always available
	$\overline{\text{MCLR}}$	—	—	I	ST	Active-low Master Clear (device Reset) input; enabled when configuration bit MCLRE = 1.

Legend: AN = Analog input or output; TTL = TTL compatible input; HV = High Voltage; OD = Open Drain; XTAL = Crystal; CMOS = CMOS compatible input or output; ST = Schmitt Trigger input with CMOS levels; I^2C = Schmitt Trigger input with I^2C.

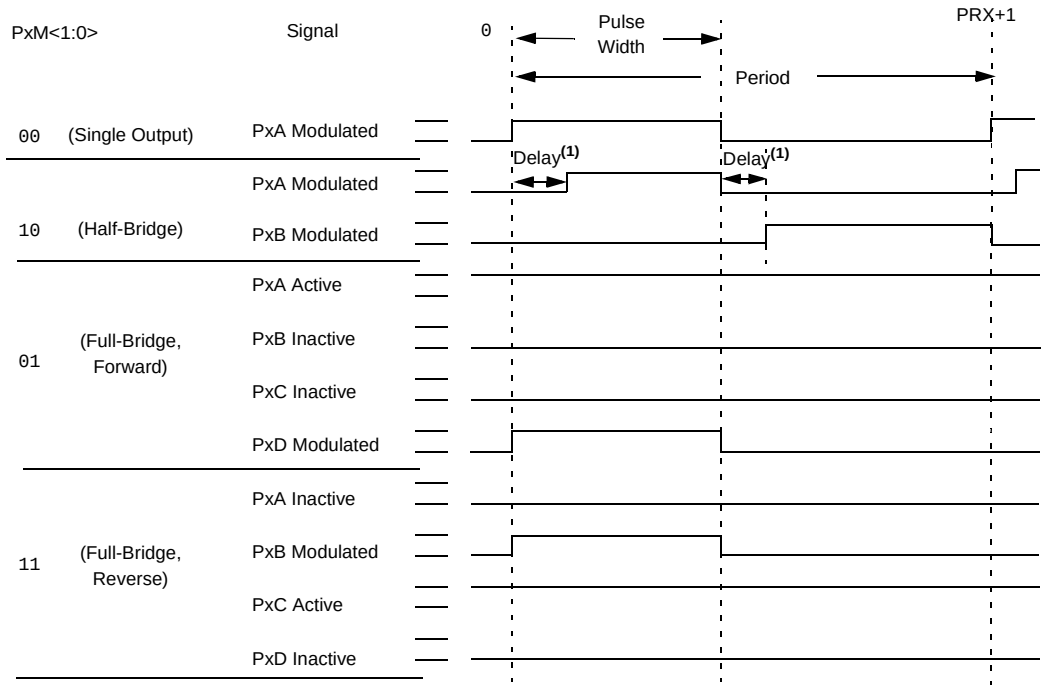
Note 1: Alternate pin assignment for P3A/CCP3 when Configuration bit CCP3MX is clear.

TABLE 14-12: EXAMPLE PIN ASSIGNMENTS FOR VARIOUS PWM ENHANCED MODES

ECCP Mode	PxM<1:0>	CCPx/PxA	PxB	PxC	PxD
Single	00	Yes(1)	Yes(1)	Yes(1)	Yes(1)
Half-Bridge	10	Yes	Yes	No	No
Full-Bridge, Forward	01	Yes	Yes	Yes	Yes
Full-Bridge, Reverse	11	Yes	Yes	Yes	Yes

Note 1: PWM Steering enables outputs in Single mode.

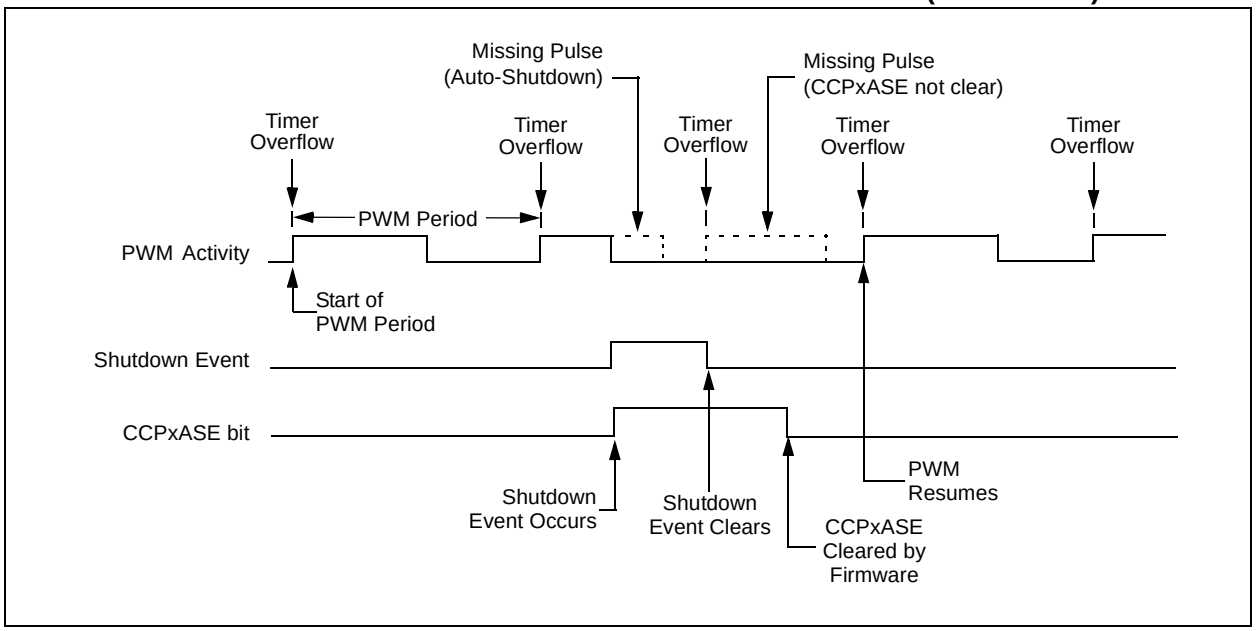
FIGURE 14-6: EXAMPLE PWM (ENHANCED MODE) OUTPUT RELATIONSHIPS (ACTIVE-HIGH STATE)



Relationships:
- Period = 4 * Tosc * (PRx + 1) * (TMRx Prescale Value)
- Pulse Width = Tosc * (CCPRxL<7:0>:CCPxCON<5:4>) * (TMRx Prescale Value)
- Delay = 4 * Tosc * (PWMxCON<6:0>)

Note 1: Dead-band delay is programmed using the PWMxCON register (**Section 14.4.5 "Programmable Dead-Band Delay Mode"**).

FIGURE 14-14: PWM AUTO-SHUTDOWN WITH FIRMWARE RESTART (PXRSEN = 0)



14.4.4 AUTO-RESTART MODE

The Enhanced PWM can be configured to automatically restart the PWM signal once the auto-shutdown condition has been removed. Auto-restart is enabled by setting the PxRSEN bit in the PWMxCON register.

If auto-restart is enabled, the CCPxASE bit will remain set as long as the auto-shutdown condition is active. When the auto-shutdown condition is removed, the CCPxASE bit will be cleared via hardware and normal operation will resume.

FIGURE 14-15: PWM AUTO-SHUTDOWN WITH AUTO-RESTART (PXRSEN = 1)

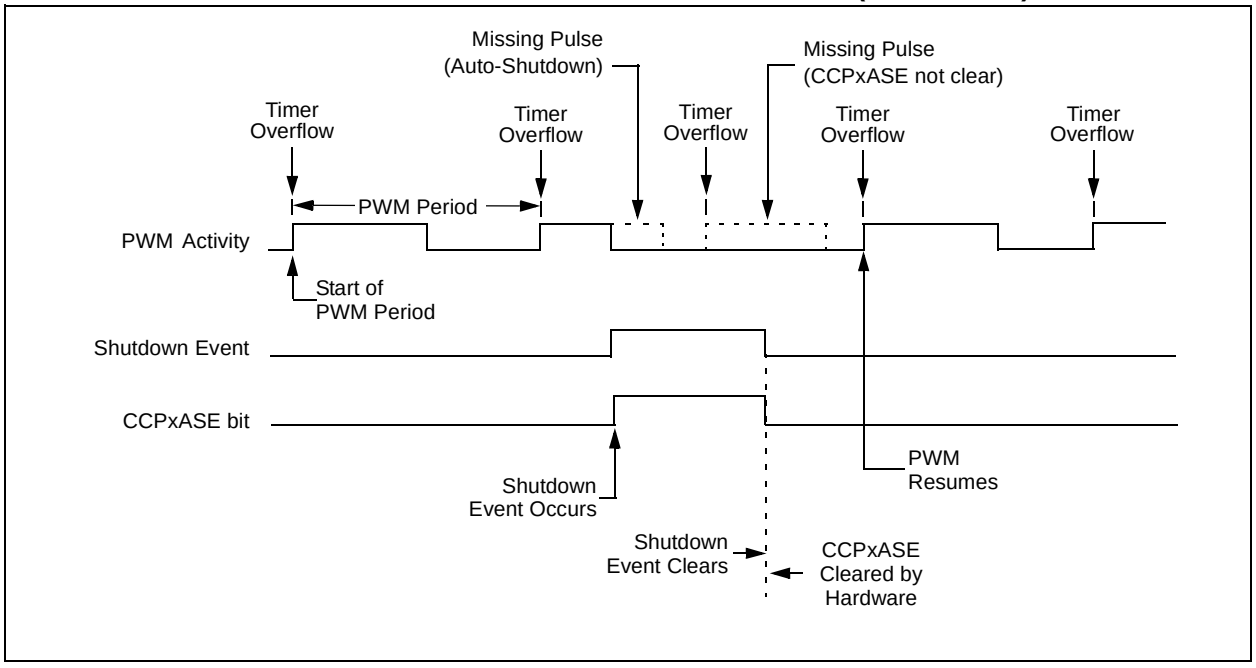


FIGURE 15-9: SPI MODE WAVEFORM (SLAVE MODE WITH CKE = 0)

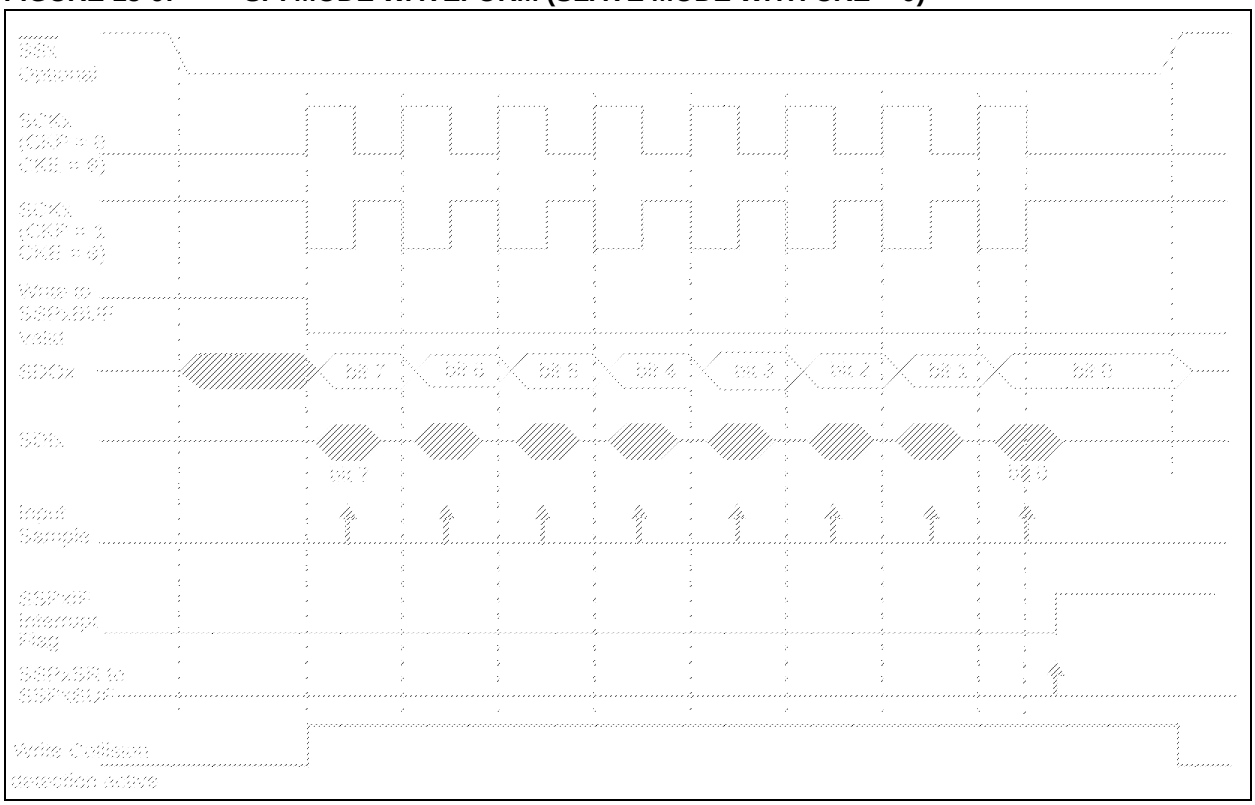


FIGURE 15-10: SPI MODE WAVEFORM (SLAVE MODE WITH CKE = 1)

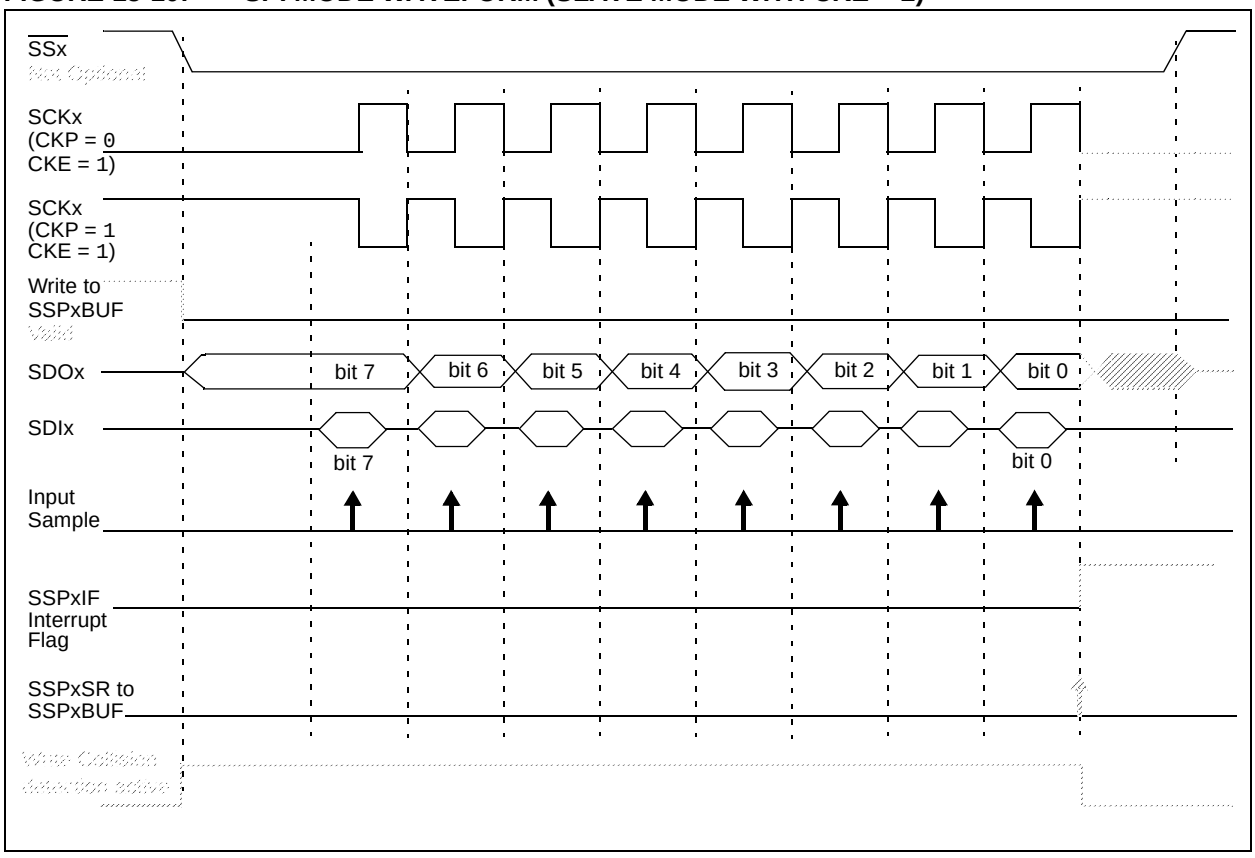


FIGURE 15-18: I²C SLAVE, 7-BIT ADDRESS, TRANSMISSION (AHEN = 0)

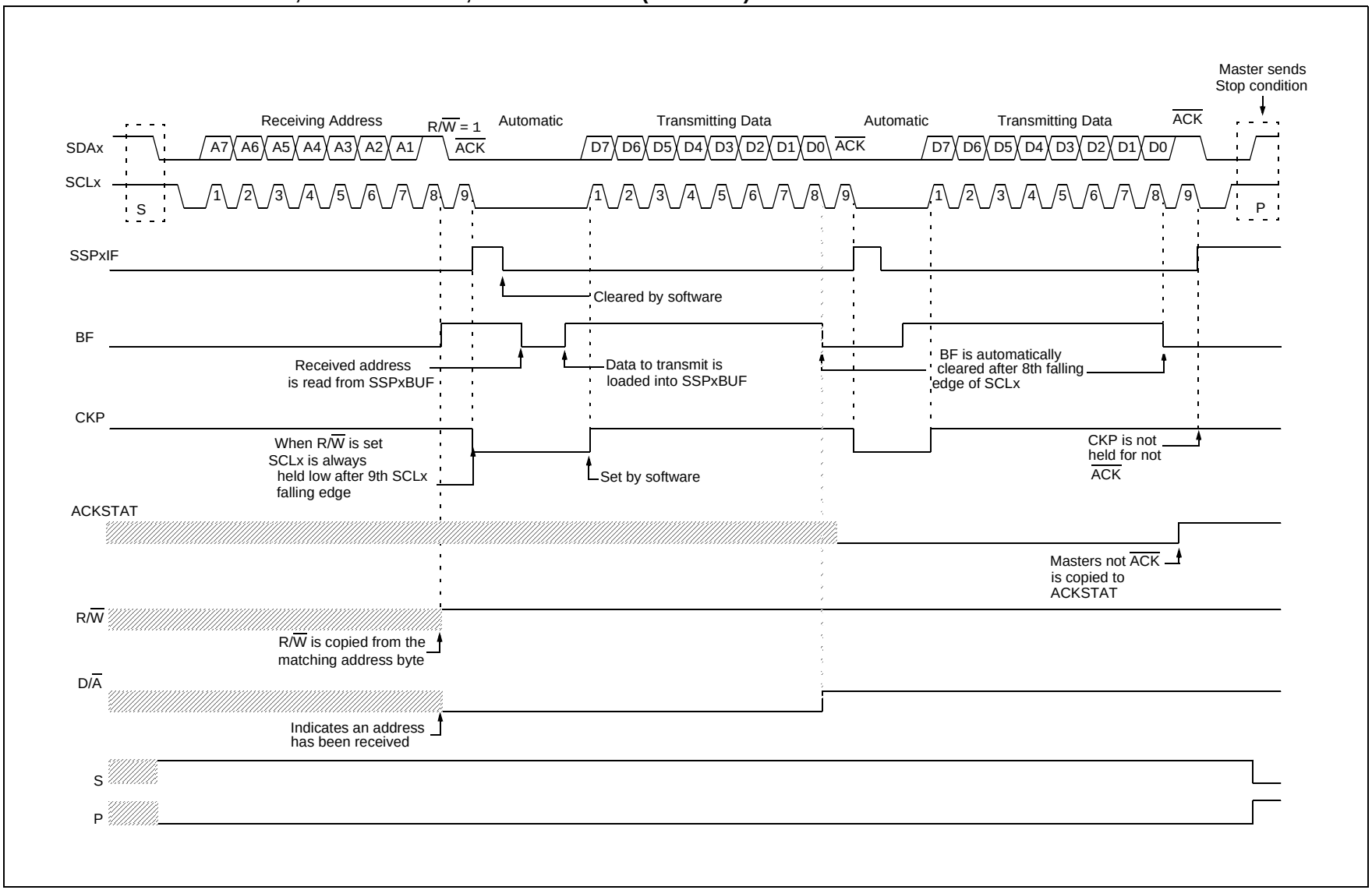


TABLE 16-4: REGISTERS ASSOCIATED WITH BAUD RATE GENERATOR

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page
BAUDCON1	ABDOVF	RCIDL	DTRXP	CKTXP	BRG16	—	WUE	ABDEN	271
BAUDCON2	ABDOVF	RCIDL	DTRXP	CKTXP	BRG16	—	WUE	ABDEN	271
PMD0	UART2MD	UART1MD	TMR6MD	TMR5MD	TMR4MD	TMR3MD	TMR2MD	TMR1MD	52
RCSTA1	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	270
RCSTA2	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	270
SPBRG1	EUSART1 Baud Rate Generator, Low Byte								—
SPBRGH1	EUSART1 Baud Rate Generator, High Byte								—
SPBRG2	EUSART2 Baud Rate Generator, Low Byte								—
SPBRGH2	EUSART2 Baud Rate Generator, High Byte								—
PIR1	—	ADIF	RC1IF	TX1IF	SSP1IF	CCP1IF	TMR2IF	TMR1IF	112
PIR3	SSP2IF	BCL2IF	RC2IF	TX2IF	CTMUIF	TMR5GIF	TMR3GIF	TMR1GIF	114
TXSTA1	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	269
TXSTA2	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	269

Legend: — = unimplemented, read as '0'. Shaded bits are not used by the BRG.

TABLE 16-5: BAUD RATES FOR ASYNCHRONOUS MODES

BAUD RATE	SYNC = 0, BRGH = 0, BRG16 = 0											
	Fosc = 64.000 MHz			Fosc = 18.432 MHz			Fosc = 16.000 MHz			Fosc = 11.0592 MHz		
	Actual Rate	% Error	SPBRxG value (decimal)	Actual Rate	% Error	SPBRGx value (decimal)	Actual Rate	% Error	SPBRGx value (decimal)	Actual Rate	% Error	SPBRGx value (decimal)
300	—	—	—	—	—	—	—	—	—	—	—	—
1200	—	—	—	1200	0.00	239	1202	0.16	207	1200	0.00	143
2400	—	—	—	2400	0.00	119	2404	0.16	103	2400	0.00	71
9600	9615	0.16	103	9600	0.00	29	9615	0.16	25	9600	0.00	17
10417	10417	0.00	95	10286	-1.26	27	10417	0.00	23	10165	-2.42	16
19.2k	19.23k	0.16	51	19.20k	0.00	14	19.23k	0.16	12	19.20k	0.00	8
57.6k	58.82k	2.12	16	57.60k	0.00	7	—	—	—	57.60k	0.00	2
115.2k	111.11k	-3.55	8	—	—	—	—	—	—	—	—	—

BAUD RATE	SYNC = 0, BRGH = 0, BRG16 = 0											
	Fosc = 8.000 MHz			Fosc = 4.000 MHz			Fosc = 3.6864 MHz			Fosc = 1.000 MHz		
	Actual Rate	% Error	SPBRGx value (decimal)	Actual Rate	% Error	SPBRGx value (decimal)	Actual Rate	% Error	SPBRGx value (decimal)	Actual Rate	% Error	SPBRGx value (decimal)
300	—	—	—	300	0.16	207	300	0.00	191	300	0.16	51
1200	1202	0.16	103	1202	0.16	51	1200	0.00	47	1202	0.16	12
2400	2404	0.16	51	2404	0.16	25	2400	0.00	23	—	—	—
9600	9615	0.16	12	—	—	—	9600	0.00	5	—	—	—
10417	10417	0.00	11	10417	0.00	5	—	—	—	—	—	—
19.2k	—	—	—	—	—	—	19.20k	0.00	2	—	—	—
57.6k	—	—	—	—	—	—	57.60k	0.00	0	—	—	—
115.2k	—	—	—	—	—	—	—	—	—	—	—	—

FIGURE 16-7: AUTO-WAKE-UP BIT (WUE) TIMING DURING NORMAL OPERATION

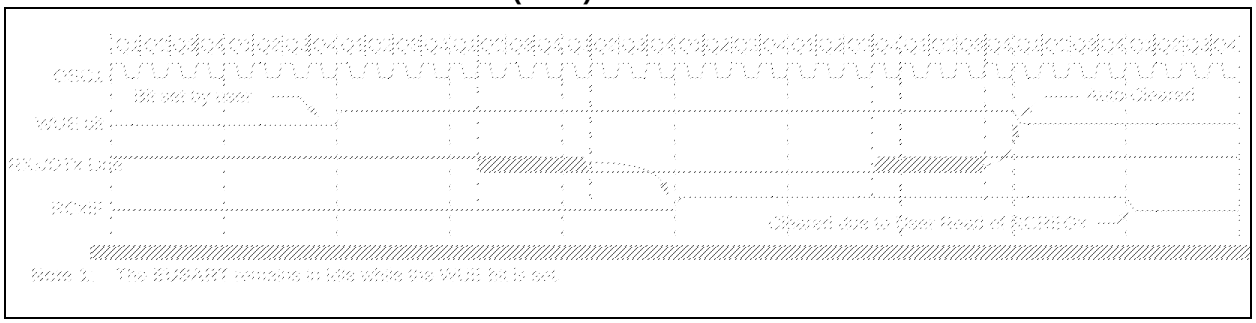
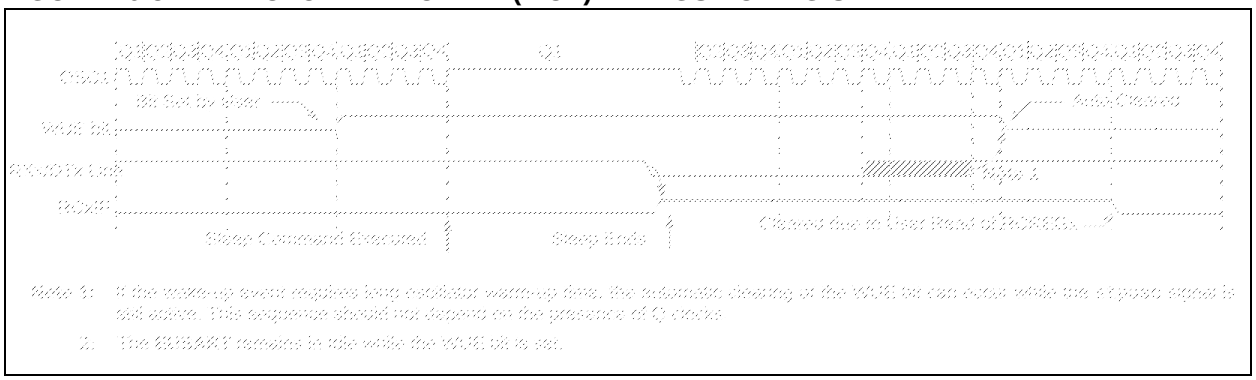


FIGURE 16-8: AUTO-WAKE-UP BIT (WUE) TIMINGS DURING SLEEP



REGISTER 19-3: CTMUICON: CTMU CURRENT CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ITRIM<5:0>						IRNG<1:0>	
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-2 **ITRIM<5:0>:** Current Source Trim bits
011111 = Maximum positive change from nominal current
011110
.
.
.
000001 = Minimum positive change from nominal current
000000 = Nominal current output specified by IRNG<1:0>
111111 = Minimum negative change from nominal current
.
.
.
100010
100001 = Maximum negative change from nominal current

bit 1-0 **IRNG<1:0>:** Current Source Range Select bits (see Table 27-4)
11 = 100 × Base current
10 = 10 × Base current
01 = Base current level
00 = Current source disabled

TABLE 19-1: REGISTERS ASSOCIATED WITH CTMU MODULE

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page
CTMUCONH	CTMUEN	—	CTMUSIDL	TGEN	EDGEN	EDGSEQEN	IDISSEN	CTTRIG	323
CTMUCONL	EDG2POL	EDG2SEL<1:0>		EDG1POL	EDG1SEL<1:0>		EDG2STAT	EDG1STAT	324
CTMUICON	ITRIM<5:0>						IRNG<1:0>		325
IPR3	SSP2IP	BCL2IP	RC2IP	TX2IP	CTMUIP	TMR5GIP	TMR3GIP	TMR1GIP	123
PIE3	SSP2IE	BCL2IE	RC2IE	TX2IE	CTMUIE	TMR5GIE	TMR3GIE	TMR1GIE	119
PIR3	SSP2IF	BCL2IF	RC2IF	TX2IF	CTMUIF	TMR5GIF	TMR3GIF	TMR1GIF	114
PMD2	—	—	—	—	CTMUMD	CMP2MD	CMP1MD	ADCMD	54

Legend: — = unimplemented, read as '0'. Shaded bits are not used during CTMU operation.

ADDWF **ADD W to Indexed (Indexed Literal Offset mode)**

Syntax: ADDWF [k] {,d}

Operands: $0 \le k \le 95$
$d \in [0,1]$

Operation: (W) + ((FSR2) + k) → dest

Status Affected: N, OV, C, DC, Z

Encoding:

0010	01d0	kkkk	kkkk

Description: The contents of W are added to the contents of the register indicated by FSR2, offset by the value 'k'.
If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored back in register 'f' (default).

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read 'k'	Process Data	Write to destination

Example: ADDWF [OFST], 0

Before Instruction
W = 17h
OFST = 2Ch
FSR2 = 0A00h
Contents of 0A2Ch = 20h
After Instruction
W = 37h
Contents of 0A2Ch = 20h

BSF **Bit Set Indexed (Indexed Literal Offset mode)**

Syntax: BSF [k], b

Operands: $0 \le f \le 95$
$0 \le b \le 7$

Operation: 1 → ((FSR2) + k)<b>

Status Affected: None

Encoding:

1000	bbb0	kkkk	kkkk

Description: Bit 'b' of the register indicated by FSR2, offset by the value 'k', is set.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write to destination

Example: BSF [FLAG_OFST], 7

Before Instruction
FLAG_OFST = 0Ah
FSR2 = 0A00h
Contents of 0A0Ah = 55h
After Instruction
Contents of 0A0Ah = D5h

SETF **Set Indexed (Indexed Literal Offset mode)**

Syntax: SETF [k]

Operands: $0 \le k \le 95$

Operation: FFh → ((FSR2) + k)

Status Affected: None

Encoding:

0110	1000	kkkk	kkkk

Description: The contents of the register indicated by FSR2, offset by 'k', are set to FFh.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read 'k'	Process Data	Write register

Example: SETF [OFST]

Before Instruction
OFST = 2Ch
FSR2 = 0A00h
Contents of 0A2Ch = 00h
After Instruction
Contents of 0A2Ch = FFh

26.11 Demonstration/Development Boards, Evaluation Kits, and Starter Kits

A wide variety of demonstration, development and evaluation boards for various PIC MCUs and dsPIC DSCs allows quick application development on fully functional systems. Most boards include prototyping areas for adding custom circuitry and provide application firmware and source code for examination and modification.

The boards support a variety of features, including LEDs, temperature sensors, switches, speakers, RS-232 interfaces, LCD displays, potentiometers and additional EEPROM memory.

The demonstration and development boards can be used in teaching environments, for prototyping custom circuits and for learning about various microcontroller applications.

In addition to the PICDEM™ and dsPICDEM™ demonstration/development board series of circuits, Microchip has a line of evaluation kits and demonstration software for analog filter design, KEELOQ® security ICs, CAN, IrDA®, PowerSmart battery management, SEEVAL® evaluation system, Sigma-Delta ADC, flow rate sensing, plus many more.

Also available are starter kits that contain everything needed to experience the specified device. This usually includes a single application and debug capability, all on one board.

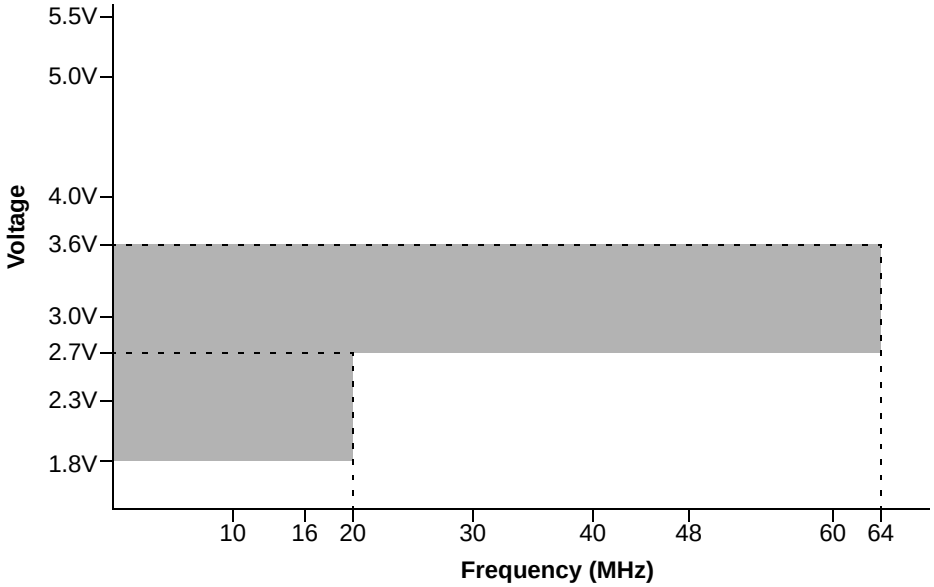
Check the Microchip web page (www.microchip.com) for the complete list of demonstration, development and evaluation kits.

26.12 Third-Party Development Tools

Microchip also offers a great collection of tools from third-party vendors. These tools are carefully selected to offer good value and unique functionality.

- Device Programmers and Gang Programmers from companies, such as SoftLog and CCS
- Software Tools from companies, such as Gimpel and Trace Systems
- Protocol Analyzers from companies, such as Saleae and Total Phase
- Demonstration Boards from companies, such as MikroElektronika, Digilent® and Olimex
- Embedded Ethernet Solutions from companies, such as EZ Web Lynx, WIZnet and IPLogika®

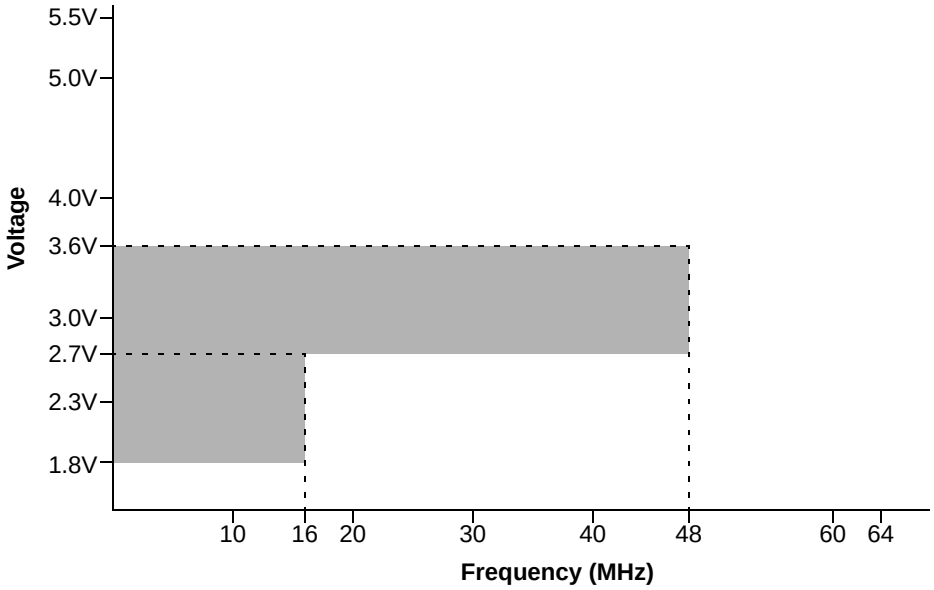
FIGURE 27-1: PIC18LF2X/4XK22 FAMILY VOLTAGE-FREQUENCY GRAPH (INDUSTRIAL TEMPERATURE)



Note 1: Maximum Frequency 20 MHz, 1.8V to 2.7V, -40°C to +85°C

2: Maximum Frequency 64 MHz, 2.7V to 3.6V, -40°C to +85°C

FIGURE 27-2: PIC18LF2X/4XK22 FAMILY VOLTAGE-FREQUENCY GRAPH (EXTENDED TEMPERATURE)



Note 1: Maximum Frequency 16 MHz, 1.8V to 2.7V, +85°C to +125°C

2: Maximum Frequency 48 MHz, 2.7V to 3.6V, +85°C to +125°C

FIGURE 27-5: HIGH/LOW-VOLTAGE DETECT CHARACTERISTICS

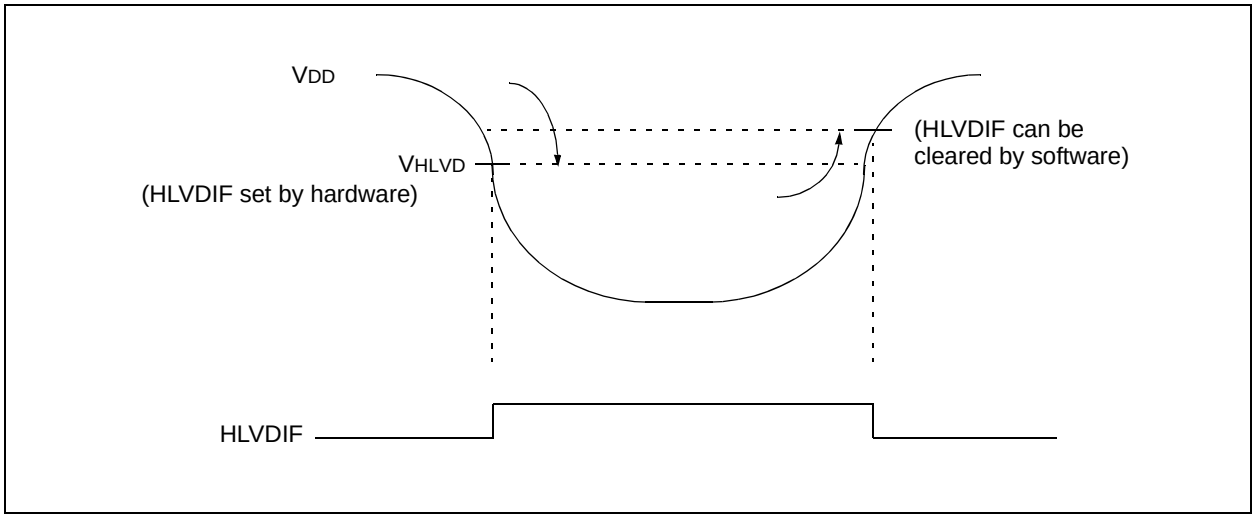


TABLE 27-5: HIGH/LOW-VOLTAGE DETECT CHARACTERISTICS

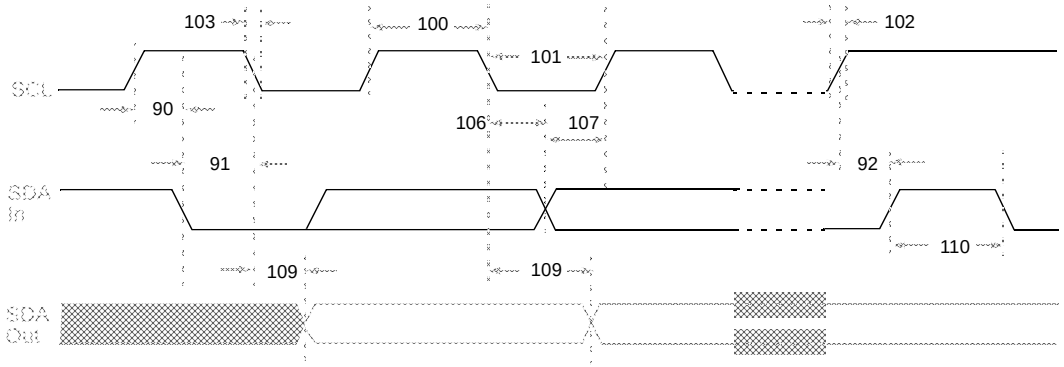
Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +125°C								
Param No.	**Symbol**	**Characteristic**	**HLVDL<3:0>**	**Min**	**Typ†**	**Max**	**Units**	**Conditions**
		HLVD Voltage on VDD Transition High-to-Low	0000	1.69	1.84	1.99	V	
			0001	1.92	2.07	2.22	V	
			0010	2.08	2.28	2.48	V	
			0011	2.24	2.44	2.64	V	
			0100	2.34	2.54	2.74	V	
			0101	2.54	2.74	2.94	V	
			0110	2.62	2.87	3.12	V	
			0111	2.76	3.01	3.26	V	
			1000	3.00	3.30	3.60	V	
			1001	3.18	3.48	3.78	V	
			1010	3.44	3.69	3.94	V	
			1011	3.66	3.91	4.16	V	
			1100	3.90	4.15	4.40	V	
			1101	4.11	4.41	4.71	V	
			1110	4.39	4.74	5.09	V	
			1111	V(HLVDIN pin)			v	

† Production tested at TAMB = 25°C. Specifications over temperature limits ensured by characterization.

TABLE 27-15: I²C BUS START/STOP BITS REQUIREMENTS (SLAVE MODE)

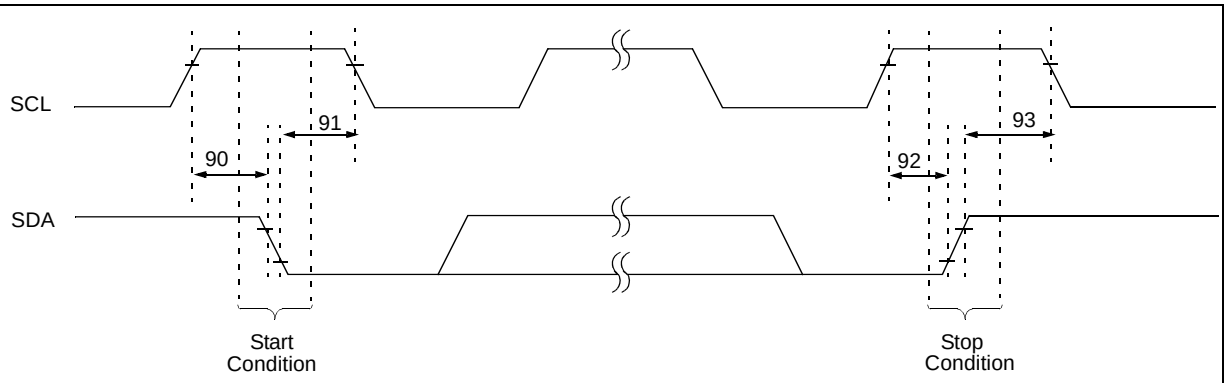
Param. No.	Symbol	Characteristic		Min	Max	Units	Conditions
90	TSU:STA	Start Condition Setup Time	100 kHz mode	4700	—	ns	Only relevant for Repeated Start condition
			400 kHz mode	600	—		
91	THD:STA	Start Condition Hold Time	100 kHz mode	4000	—	ns	After this period, the first clock pulse is generated
			400 kHz mode	600	—		
92	TSU:STO	Stop Condition Setup Time	100 kHz mode	4700	—	ns	
			400 kHz mode	600	—		
93	THD:STO	Stop Condition Hold Time	100 kHz mode	4000	—	ns	
			400 kHz mode	600	—		

FIGURE 27-18: I²C BUS DATA TIMING



Note: Refer to Figure 27-6 for load conditions.

FIGURE 27-19: MASTER SSP I²C BUS START/STOP BITS TIMING WAVEFORMS



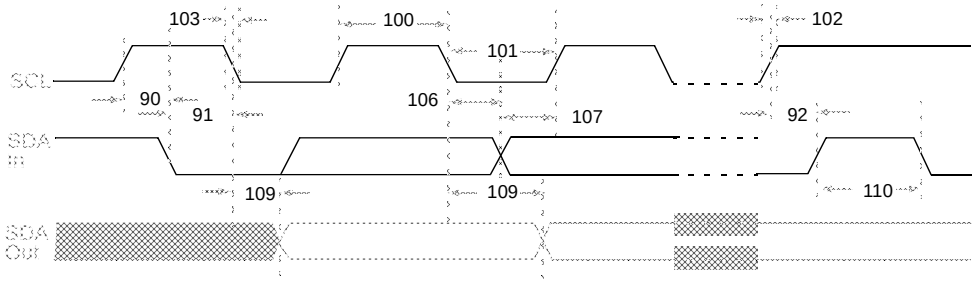
Note: Refer to Figure 27-6 for load conditions.

TABLE 27-17: MASTER SSP I²C BUS START/STOP BITS REQUIREMENTS

Param. No.	Symbol	Characteristic		Min	Max	Units	Conditions
90	TSU:STA	Start Condition Setup Time	100 kHz mode	2(TOSC)(BRG + 1)	—	ns	Only relevant for Repeated Start condition
			400 kHz mode	2(TOSC)(BRG + 1)	—		
			1 MHz mode(1)	2(TOSC)(BRG + 1)	—		
91	THD:STA	Start Condition Hold Time	100 kHz mode	2(TOSC)(BRG + 1)	—	ns	After this period, the first clock pulse is generated
			400 kHz mode	2(TOSC)(BRG + 1)	—		
			1 MHz mode(1)	2(TOSC)(BRG + 1)	—		
92	TSU:STO	Stop Condition Setup Time	100 kHz mode	2(TOSC)(BRG + 1)	—	ns	
			400 kHz mode	2(TOSC)(BRG + 1)	—		
			1 MHz mode(1)	2(TOSC)(BRG + 1)	—		
93	THD:STO	Stop Condition Hold Time	100 kHz mode	2(TOSC)(BRG + 1)	—	ns	
			400 kHz mode	2(TOSC)(BRG + 1)	—		
			1 MHz mode(1)	2(TOSC)(BRG + 1)	—		

Note 1: Maximum pin capacitance = 10 pF for all I²C pins.

FIGURE 27-20: MASTER SSP I²C BUS DATA TIMING



Note: Refer to Figure 27-6 for load conditions.

FIGURE 28-5: PIC18LF2X/4XK22 DELTA IPD BROWN-OUT RESET (BOR)

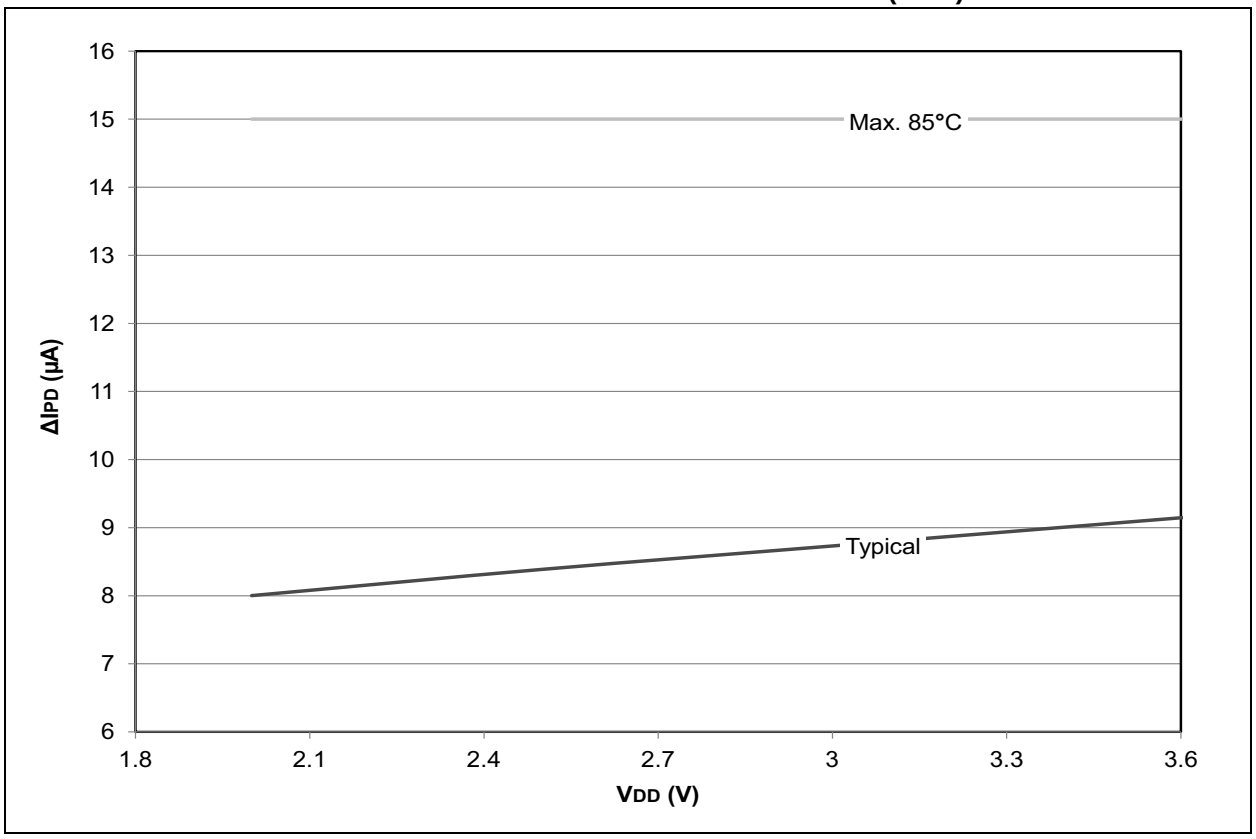


FIGURE 28-6: PIC18F2X/4XK22 DELTA IPD BROWN-OUT RESET (BOR)

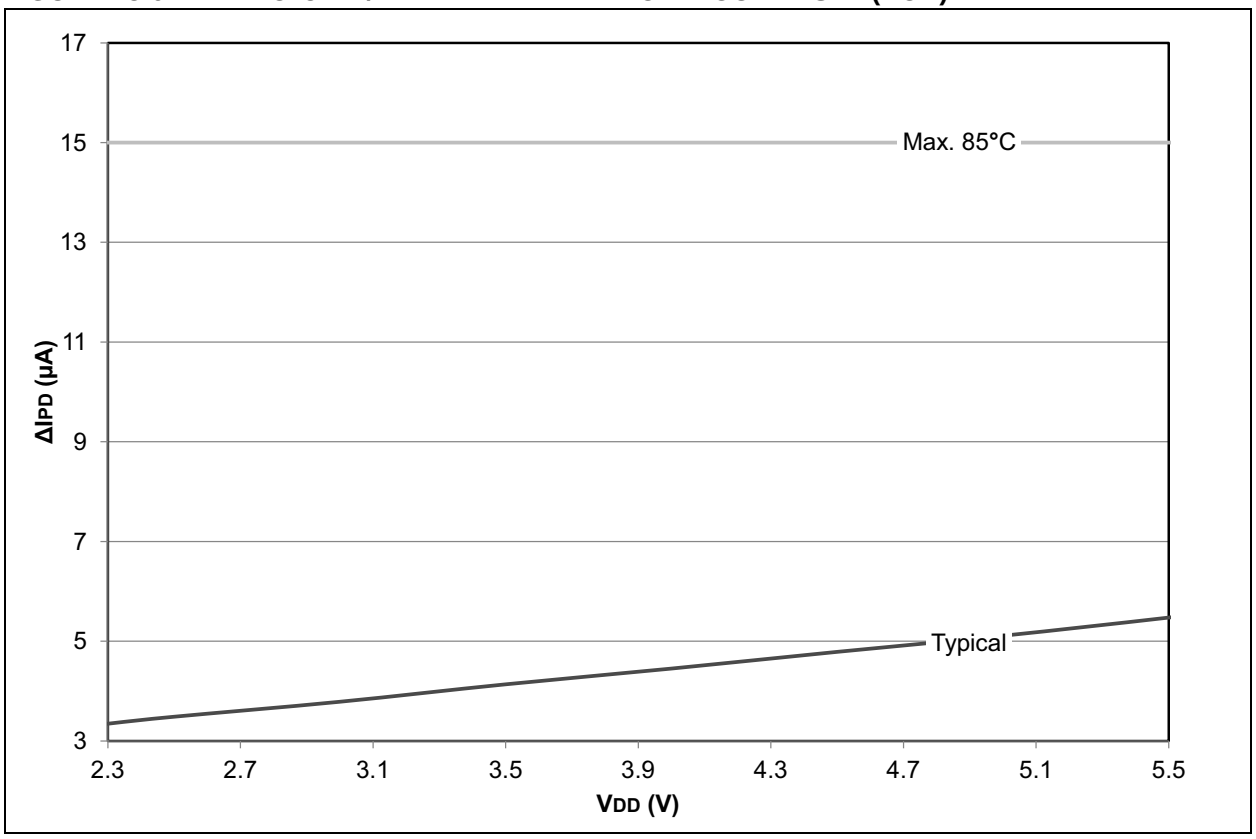


FIGURE 28-60: PIC18LF2X/4XK22 TYPICAL IDD: PRI_IDLE EC MEDIUM POWER

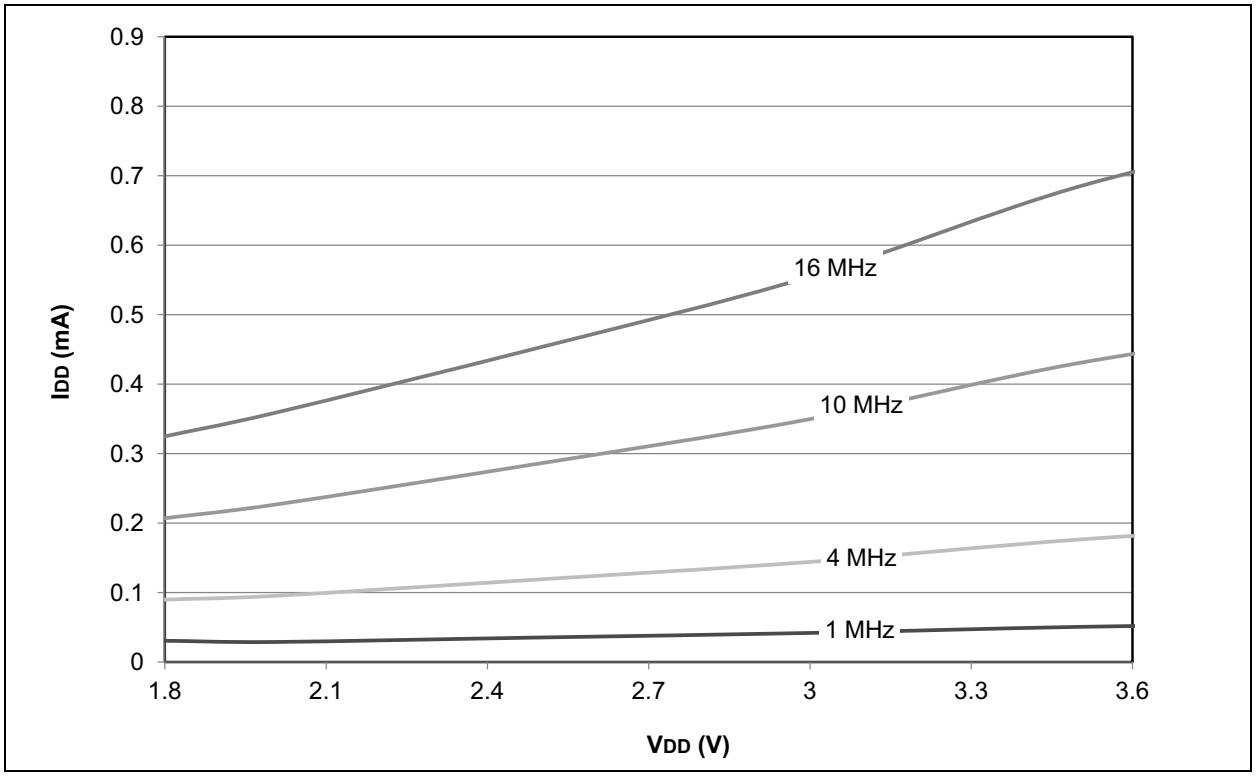
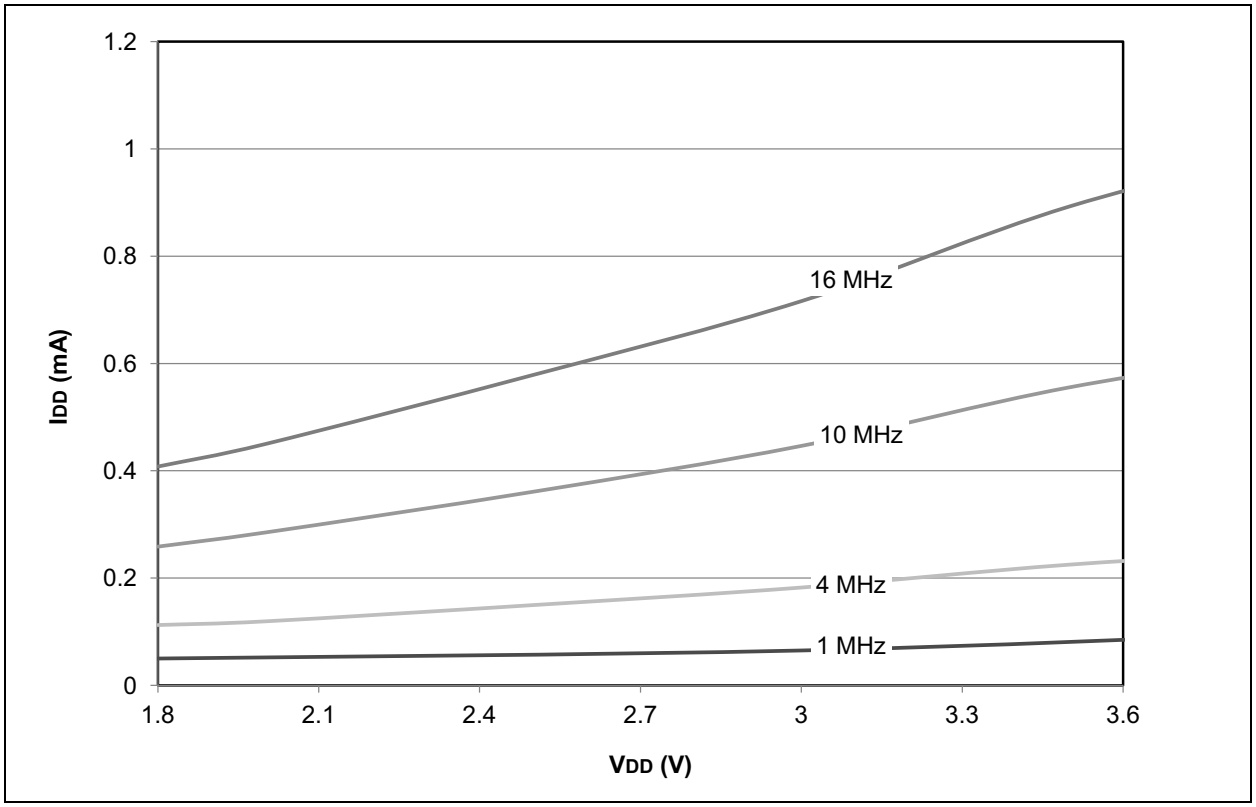
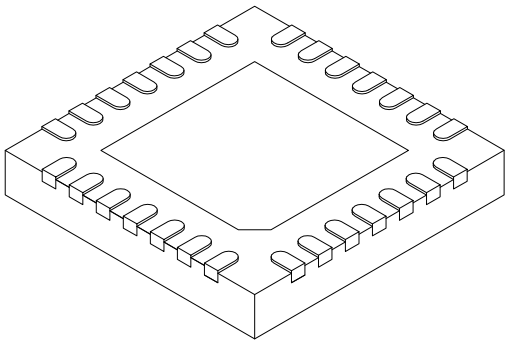


FIGURE 28-61: PIC18LF2X/4XK22 MAXIMUM IDD: PRI_IDLE EC MEDIUM POWER



28-Lead Plastic Quad Flat, No Lead Package (ML) - 6x6 mm Body [QFN] With 0.55 mm Terminal Length

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units	MILLIMETERS		
Dimension	Limits	MIN	NOM	MAX
Number of Pins	N		28	
Pitch	e		0.65 BSC	
Overall Height	A	0.80	0.90	1.00
Standoff	A1	0.00	0.02	0.05
Terminal Thickness	A3		0.20 REF	
Overall Width	E		6.00 BSC	
Exposed Pad Width	E2	3.65	3.70	4.20
Overall Length	D		6.00 BSC	
Exposed Pad Length	D2	3.65	3.70	4.20
Terminal Width	b	0.23	0.30	0.35
Terminal Length	L	0.50	0.55	0.70
Terminal-to-Exposed Pad	K	0.20	-	-

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Package is saw singulated
3. Dimensioning and tolerancing per ASME Y14.5M.

   BSC: Basic Dimension. Theoretically exact value shown without tolerances.

   REF: Reference Dimension, usually without tolerance, for information purposes only.

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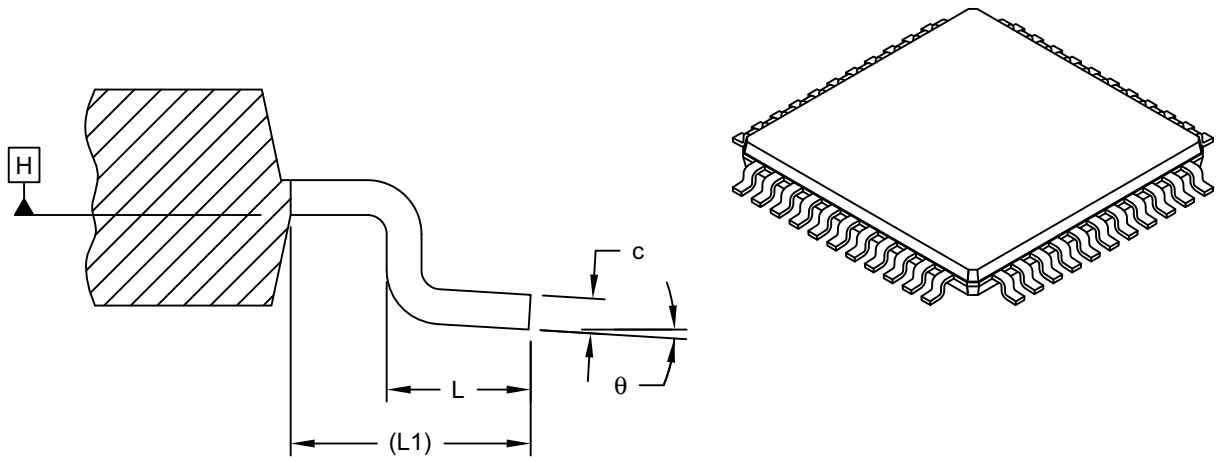
44-Lead Plastic Thin Quad Flatpack (PT) - 10x10x1.0 mm Body [TQFP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



SECTION A-A

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Leads	N		44	
Lead Pitch	e		0.80 BSC	
Overall Height	A	-	-	1.20
Standoff	A1	0.05	-	0.15
Molded Package Thickness	A2	0.95	1.00	1.05
Overall Width	E		12.00 BSC	
Molded Package Width	E1		10.00 BSC	
Overall Length	D		12.00 BSC	
Molded Package Length	D1		10.00 BSC	
Lead Width	b	0.30	0.37	0.45
Lead Thickness	c	0.09	-	0.20
Lead Length	L	0.45	0.60	0.75
Footprint	L1		1.00 REF	
Foot Angle	θ	0°	3.5°	7°

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Exact shape of each corner is optional.
3. Dimensioning and tolerancing per ASME Y14.5M

   BSC: Basic Dimension. Theoretically exact value shown without tolerances.

   REF: Reference Dimension, usually without tolerance, for information purposes only.

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